



DMN66D0LDWQ

#### **Product Summary**

BV <sub>DSS</sub>	Rds(on) max	ID мах Та = +25°С
60V	5Ω @ V <sub>GS</sub> = 10V	217mA
000	6Ω @ Vgs = 5V	209mA

## **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

Load Switch

#### DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

#### **Features and Benefits**

- **Dual N-Channel MOSFET**
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- **ESD** Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN66D0LDWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

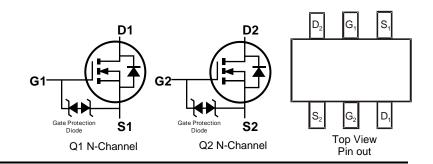
#### **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 @3
- Terminal Connections: See Diagram Weight: 0.006 grams (Approximate)



SOT363

Top View



## Ordering Information (Note 4)

	Part Number	Case	Packaging			
	DMN66D0LDWQ-7	SOT363	3,000/Tape & Reel			
	DMN66D0LDWQ-13	SOT363	10000/Tape & Reel			
Notes:	1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					

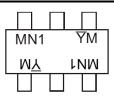
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## Marking Information



MN1= Product Type Marking Code  $\overline{Y}M = Date Code Marking$  $\overline{Y}$ = Year (ex: H = 2020) M = Month (ex: 9 = September)

#### Date Code Key

•												
Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	G	Н		J	K	L	М	N	0	Р	R	S
								•	-			_
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec

DMN66D0LDWQ Document number: DS42018 Rev. 2 - 2

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## Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		VDSS	60	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 6), VGs = 10V	Steady T <sub>A</sub> = +25°C		217	(
	State T <sub>A</sub> = +70°C	ID	174	mA
Pulsed Drain Current (10µs Pulse, 1% Duty Cyc	cle)	Ідм	0.6	А
Maximum Continuous Body Diode Forward Cur	rent (Note 6)	Is	217	mA

#### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	0.40	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>0JA</sub>	310	°C/W
Total Power Dissipation (Note 6)		PD	0.47	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	264	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	0°

## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

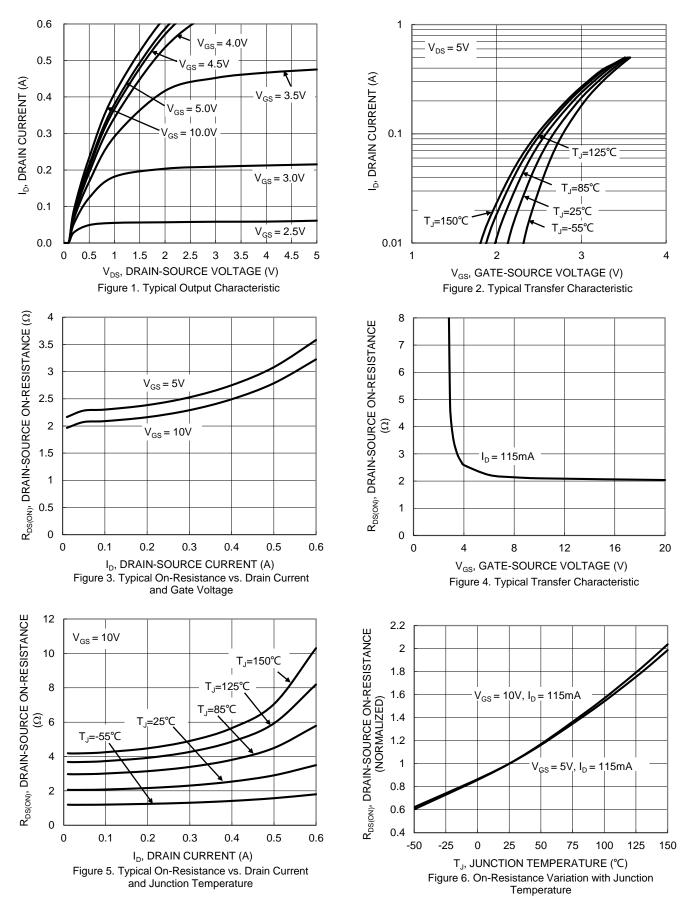
Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)			, ,,				
Drain-Source Breakdown Voltage	BVDSS	60	_		V	$V_{GS} = 0V, I_D = 10\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1.0	μA	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Body Leakage	I <sub>GSS</sub>	_	—	±5	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.2	_	2.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Desser		2.3	6	Ω	V <sub>GS</sub> = 5V, I <sub>D</sub> = 0.115A	
	Rds(on)		2.1	5	52	V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.115A	
Diode Forward Voltage	Vsd	_	0.8	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 115mA	
DYNAMIC CHARACTERISTICS (Note 8)						·	
Input Capacitance	Ciss		29.3	_	pF		
Output Capacitance	Coss		3.6	_	pF	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	2.6	_	pF		
Gate Resistance	Rg	_	65	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1.0MHz$	
Total Gate Charge, V <sub>GS</sub> = 10V	Qg	_	0.9	_			
Total Gate Charge, V <sub>GS</sub> = 4.5V	Qg	_	0.5	_	nC	)/ 20)/ I= 150m A	
Gate-Source Charge	Qgs	_	0.1	_		V <sub>DS</sub> = 30V, I <sub>D</sub> = 150mA	
Gate-Drain Charge	Q <sub>gd</sub>		0.2	_			
Turn-On Delay Time	t <sub>D(ON)</sub>		3.7	_			
Turn-On Rise Time	tR		1.4	_	ns	$V_{DD} = 30V, I_D = 0.115A, V_{GEN} = 10V,$	
Turn-Off Delay Time	tD(OFF)		11	_	115	$R_{GEN} = 25\Omega$	
Turn-Off Fall Time	tF		5.3	_			

Notes:

Device mounted on FR-4 PCB, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guarantee by design. Not subject to production testing.



# DMN66D0LDWQ





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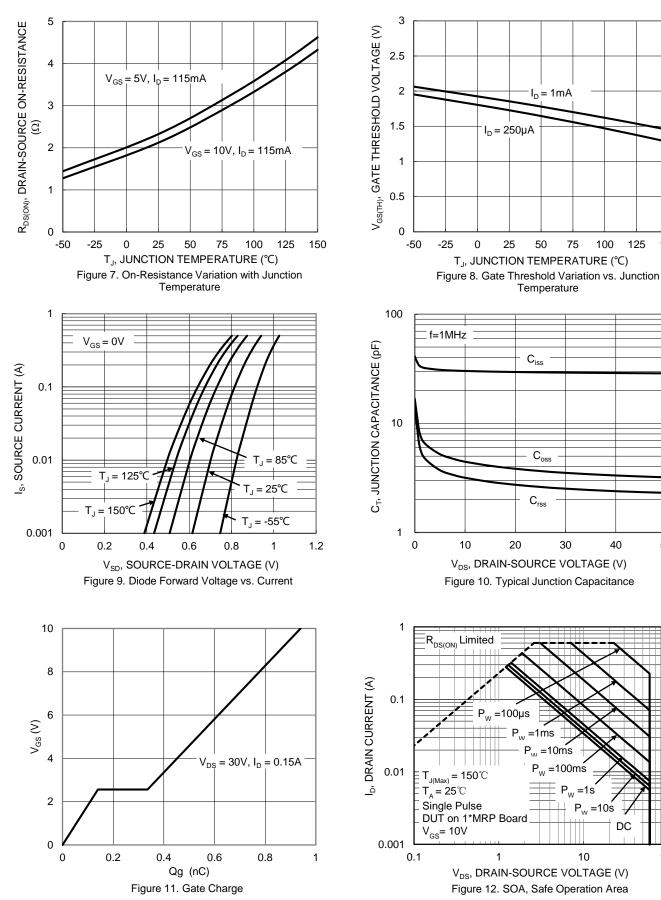
100

40

50

125

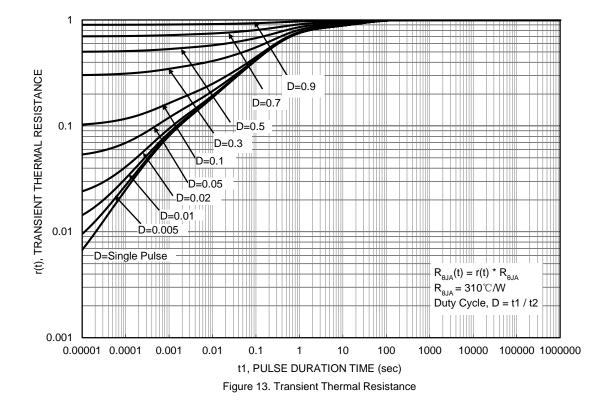
150



100

DC

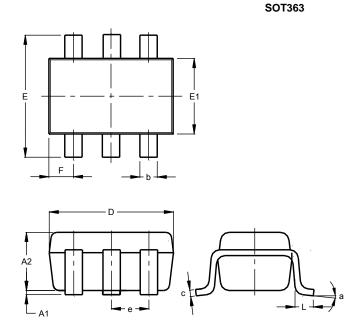






# **Package Outline Dimensions**

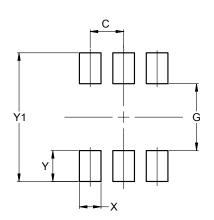
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT363								
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.10	0.30	0.25					
С	0.10	0.22	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	C	).650 E	SC					
F	0.40	0.45	0.425					
_	0.25	0.40	0.30					
а	0°	8°						
All I	All Dimensions in mm							

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Ý	0.600
Y1	2.500

SOT363



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